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GAP-245P-S8

2U Rugged Edge Server- Front I/O - Front Power Supply Dual Socket 5th/4th Gen Intel[®] Xeon[®] Scalable Processors





GAP is a product family of Rugged aluminium Servers and Workstations designed for Edge applications that require a robust MIL-GRADE certified computing platform, suitable for operations in critical environments.

2U PLATFORM 450 MM

2 CPU 4TB

UP TO 3 HOT SWAP SSD 6 I/O Boards

GAP-245P-S8 Rugged Edge Servers are powered by dual-socket 5th Gen Intel® Xeon® / 4th Gen Intel® Xeon® Scalable Processors renowned for their robust architecture with enhanced AI acceleration and advanced security capabilities. Offering improved performance and efficiency, these servers are tailored to meet the demanding requirements of modern computing environments at the Edge. The integrated IPMI services support monitoring, control, and management functions, sending alarm notifications in case of critical events.

GAP-245P-S8 are designed for 19" rackmounting and have a 2U chassis with a depth of 450mm. The design, featuring front-mounted I/O ports and power supply, strategically positions all I/O interfaces at the front of the chassis, ideal for 'front-only' installations.

The GAP-245P-S8 offers versatile storage options, including support for two on board M.2 NVME SSD and either up to one 2.5" SAS SSD or two U.2 NVMe SSD or three 2.5" SATA removable SSD.

Moreover, this rugged server can accommodate up to six full-height, full-length PCIe cards.

Additional boards can be provided with a dedicated retainer kit for an optimal protection against shocks and vibrations also during transport.

Built to meet MIL-STD-810F standards for temperature and shock resistance, as well as MIL-STD-167-1A standards for vibration tolerance, GAP Rugged Edge Servers ensure reliable operation under the challenging conditions often found at the Edge. Additionally, they can optionally be configured to comply with MIL-STD-461 standards for EMI/EMC, featuring MIL-grade connectors for either the power input or both the I/O connectors and power supply inputs.

All units are shipped with an inventory list to guarantee configuration control and reproducibility over time. Additionally, upon request, all server configurations can undergo specific thermal or mechanical environmental stress tests.



Technical Specifications



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Power Supply

CPU	5 th Gen Intel [®] Xeon [®] / 4 th Gen Intel [®] Xeon [®] Scalable processors, Dual Socket LGA- 4677 (Socket E) supported, CPU TDP Up to 270W TDP
Memory	Up to 4TB ECC RDIMM, DDR5-4800MT/s in 16 DIMM slots
Chipset	Intel [®] C741
Graphics	1 Aspeed AST2600 BMC port
Network Connectivity	1 x Dedicated IPMI LAN port 2 x AIOM slots supporting 100GbE / 25GbE / 2.5GbE / GbE ports OCP 3.0 NICs
Storage	Internal: 2 x NVMe M.2, M-Key, 2280 Removable: Up to 1x 2.5" SAS SSD or Up to 2x U.2 NVMe SSD or Up to 3x 2.5" SATA SSD
TPM	1x TPM Header
11 IVI	
Motherboard I/O shield	1 x VGA, 2 x USB 3.0, 1 x IPMI; 1 x COM (available on the front panel)
Motherboard	
Motherboard I/O shield	(available on the front panel) 6 x PCle x16 FHHL Windows® 11 IoT Enterprise, Windows®
Motherboard I/O shield Expansion slots Operative	(available on the front panel) 6 x PCle x16 FHHL Windows® 11 IoT Enterprise, Windows® 10 IoT Enterprise LTSC, Windows® Server 2022, Windows® Server 2019, Linux
Motherboard I/O shield Expansion slots Operative Systems	(available on the front panel) 6 x PCle x16 FHHL Windows® 11 IoT Enterprise, Windows® 10 IoT Enterprise LTSC, Windows® Server 2022, Windows® Server 2019, Linux IPMI2.0, SPM, Watchdog; SNMP and e-mail

AC or DC Redundant Power Supply -

Optional AC Single

Mechanical

Dimensions	483 x 88 x 450 mm (W x H x D)	
Material	Aluminum with surface passivation treatment	
Colour	Black / RAL 9005 - Powder Coating	
Mounting	2U 19" rackmount chassis Optional Telescopic slides	
Configuration	Front I/O - Front Power Supply	
Front Panel Leds / Buttons / Connectors	Power On/Off button with LED Reset button with LED	
Fans	4x Hot Swap removable PWM fans	

Environmental - (Design to meet)

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Operating Temperatures	0°C to +50°C MIL-STD-810H, Method 501.7 & 502.7 -20°C to +60°C (depending on configuration)	
Storage Temperature	-40°C to +70°C MIL-STD-810H, Method 501.7 & 502.7	
Humidity	5% – 95% non-condensing MIL-STD-810H 507.6	
Operating Vibrations	MIL-STD-167-1A, Type I	
Not Operating Vibrations	1.17 Grms, 5-500 Hz MIL-STD-810H, Method 514.8	
Operating Shocks	20g / 11ms – half sine MIL-STD-810G, Method 516.7	
EMC	Directive 2014/35/UE-LVD Directive 2014/30/UE-EMC Directive 2011/65/UE - RoHS Regulation EC No 1907/2006 MIL-STD-461G (on request)	

GAP servers and workstations are designed in accordance with the environmental specifications indicated. Some parameters depend on the configuration. Equipment may be subjected to dedicated test profiles.